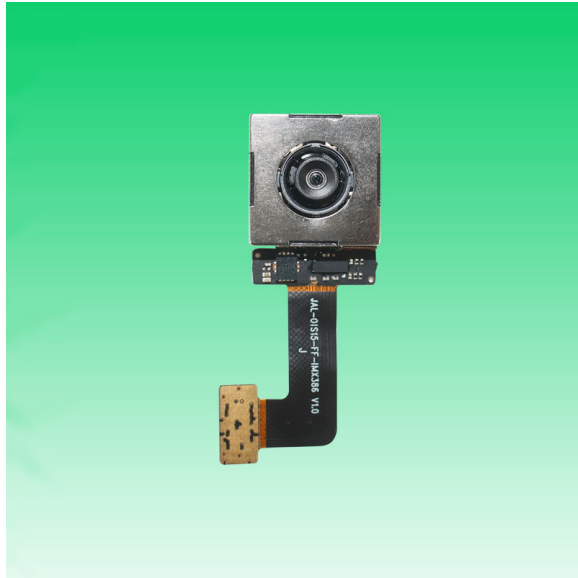
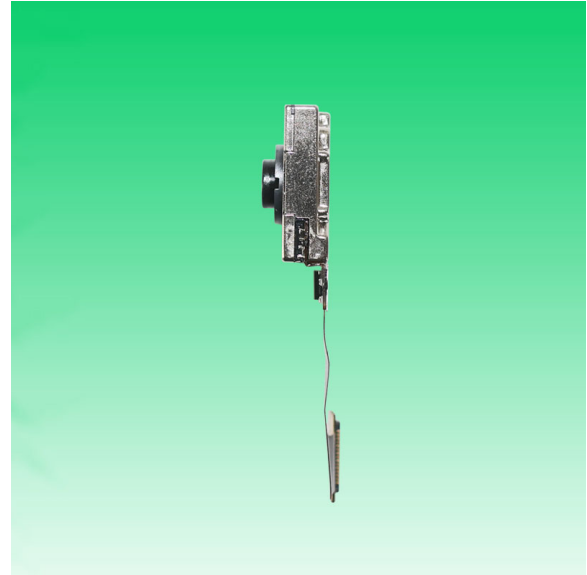


KLT-OIS-OFA68-IMX386 V1.0**12MP Sony IMX386 OIS MGS MIPI Interface Fixed Focus Camera Module**

Camera Module No.	KLT-OIS-OFA68-IMX386 V1.0
Resolution	12MP
Image Sensor	IMX386 w/ MGS OIS
Sensor Type	1/2.86"
Pixel Size	1.25 μm x 1.25 μm
EFL	2.31 mm
F.NO	2.20
Stabilization Method	Optical Image Stabilization (OIS)
Stabilizer Type	Micro Gimbal Stabilizer (MGS)
Stabilizer Axis No.	2 Axis (Pitch and Yaw)
Stabilizer Angle	Max. 3.0°
Stabilizer Power	180 mW
Pixel	4208 x 3120
View Angle	123.0°(DFOV) 100.7.0°(HFOV) 81.0°(VFOV)
Lens Dimensions	15.40 x 15.40 x 6.82 mm
Module Size	41.75 x 19.15 mm
Module Type	Fixed Focus
Interface	MIPI
Lens Type	650nm IR Cut
Operating Temperature	-20°C to +70°C
Mating Connector	OK-14F030-04

KLT-OIS-OFA68-IMX386 V1.0**12MP Sony IMX386 OIS MGS MIPI Interface Fixed Focus Camera Module**

Top View



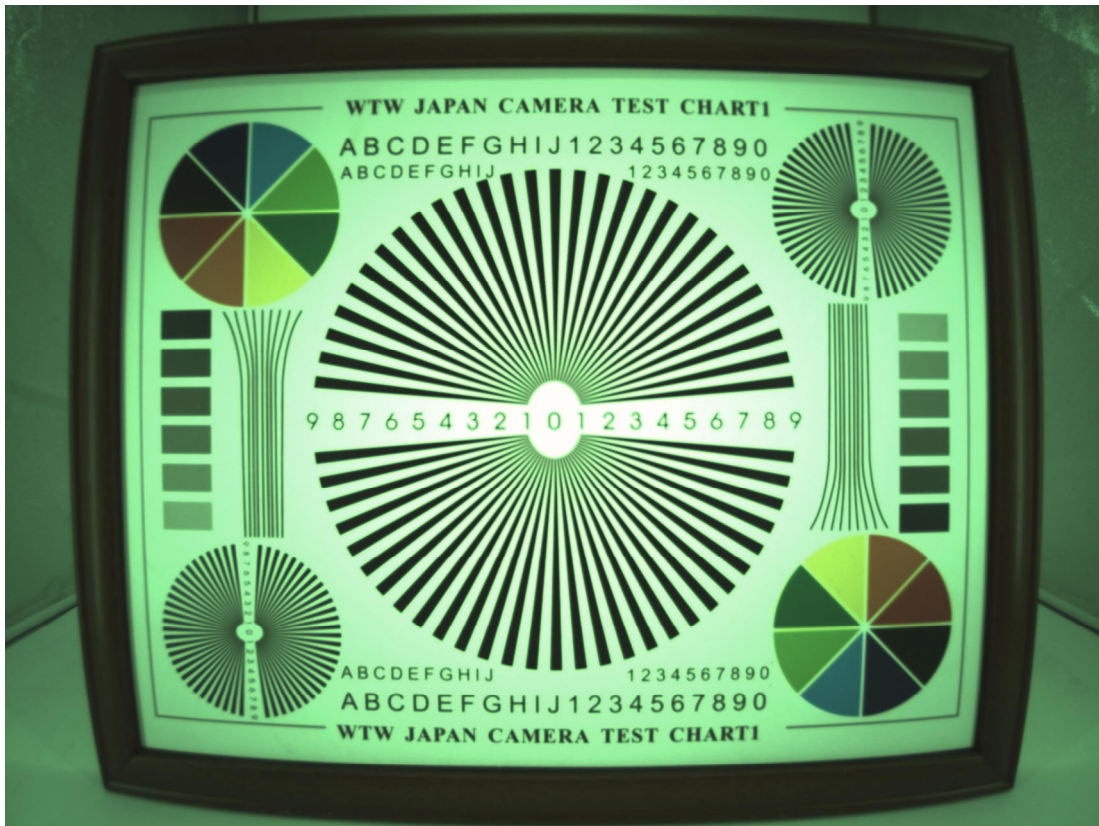
Side View



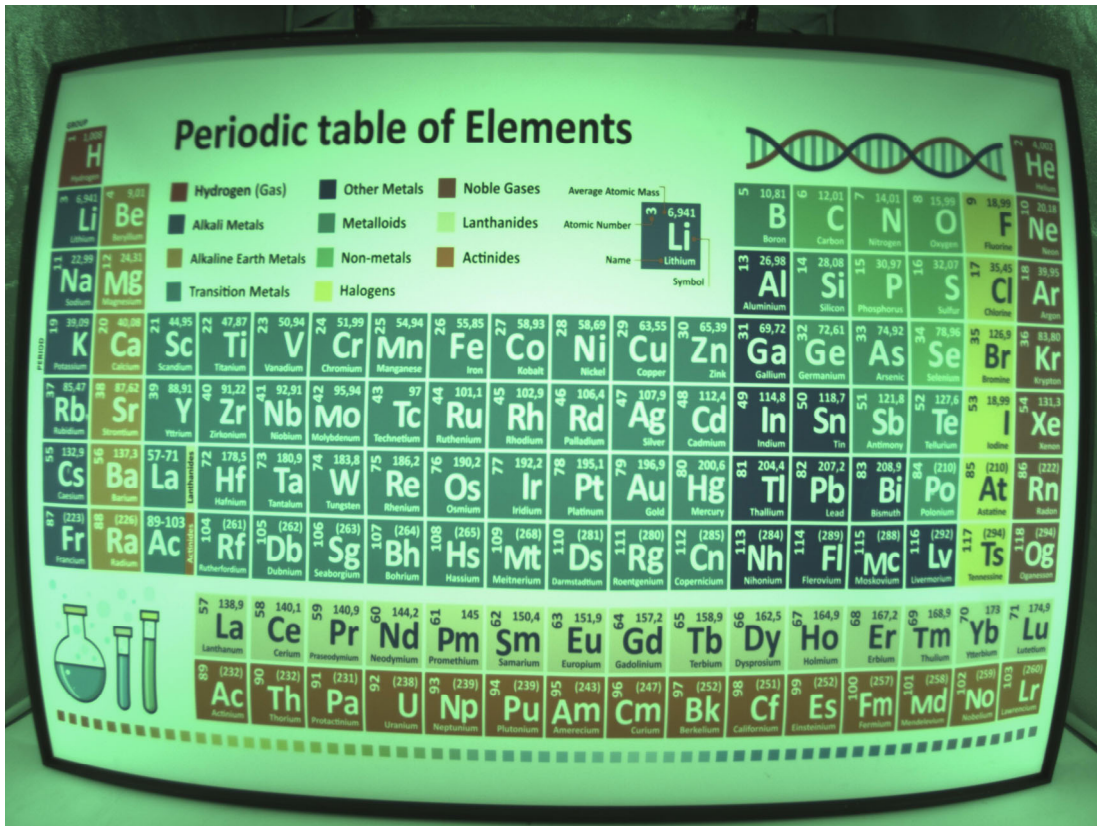
Bottom View



Mating Connector

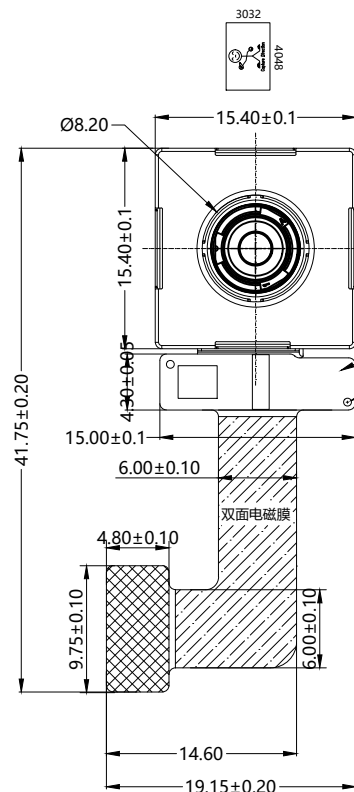




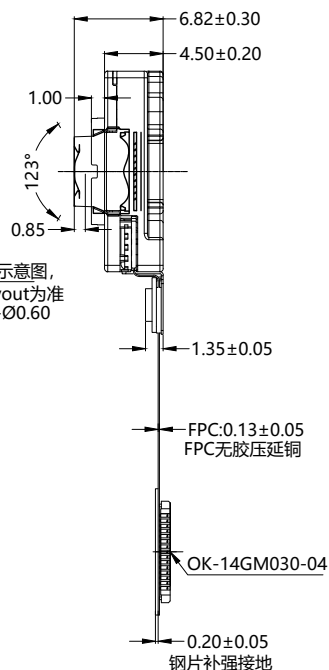


RoHS	
PIN	SIGNAL
1	MCLK
2	XVS
3	MDN4
4	MDP4
5	MDN2
6	MDP2
7	DGND
8	MCN
9	MCP
10	MDN1
11	MDP1
12	DGND
13	MDN3
14	MDP3
15	SWCLK(SSB1)
16	SWDIO(GPIOT)
17	VCM 2.8V
18	VCM 2.8V
19	VCM-GND
20	VCM-GND
21	DVDD 1.1V
22	DVDD 1.1V
23	RESET
24	DOVDD 1.8V
25	SDA
26	SCL
27	DRV-AGND
28	DRV-AVDD 2.9V
29	AGND
30	AVDD 2.8V

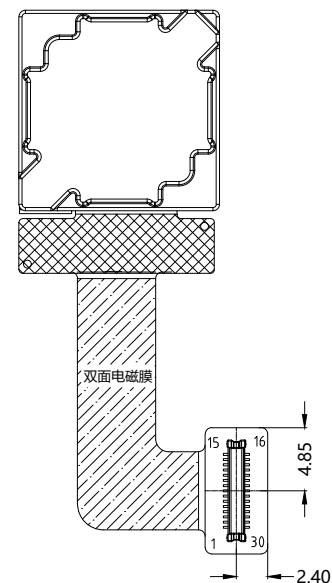
Version	Information
V1.0	First Version



TOP VIEW



SIDE VIEW



BOTTOM VIEW

NOTE:

- 1.The device slave address:0x34(W);0x35(R);
- 2.Driver I2C ID:0x52(W);0x53(R);

Parameters:

1、 Sensor specification:

Image Sensor: IMX386

Pixel: 1.25um*1.25um

Lens Type: 1/2.86

Important Voltage Description:

DVDD1.1V (external power supply);

2、 Lens specification:

FOV: 123°(D);100.7°(H);81°(V);

F/NO.: 2.2

TV distortion: $<10.7\%$

Focal length: 2.31mm

Composition: 6P+IR FILTER

IR Cut Coating: 650nm±10nm@50%

Kai Lap Technologies Group Ltd

Designed By

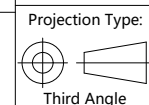
Kevin

Model Name:

KLT-OIS-OFA68-IMX386 V1.0

Checked By

Jacky



Unit: mm
Scale: 1:1

Date:	10/14/2024
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Sheet:
1 of 1

Version:	1/0
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Micro Gimbal Stabilizer (MGS) OIS-Kameramodule

Micro Gimbal Stabilizer (MGS) ist der patentierte mechanisch-optische Bildstabilisator (OIS) für Kameramodule. Die MGS-Technologie neigt den Bildsensor und das Objektiv zusammen und ermöglicht so eine Anti-Shake-Leistung für sich bewegende Geräte, um selbst bei schlechten Lichtverhältnissen ein scharfes und klares Bild aufzunehmen.

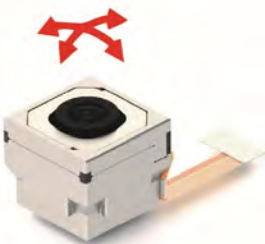


Merkmale

2-Achsen-Kompensation

Klein, leicht

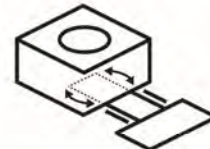
18,80 x 18,80 x 15,80 mm



Smallest
Gimbal



Multi-Axis
Compensation



Embedded
Moving FPC



One-stop
Solution



Stabilizer



Max. View Angle



Integrated
Design



Patents

Applications



**5G Smart
Helmet**



**Sport
Camera**



Drones



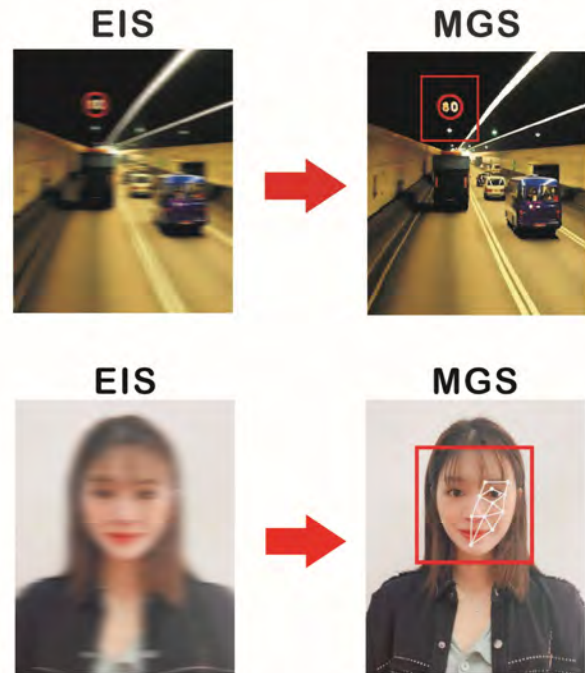
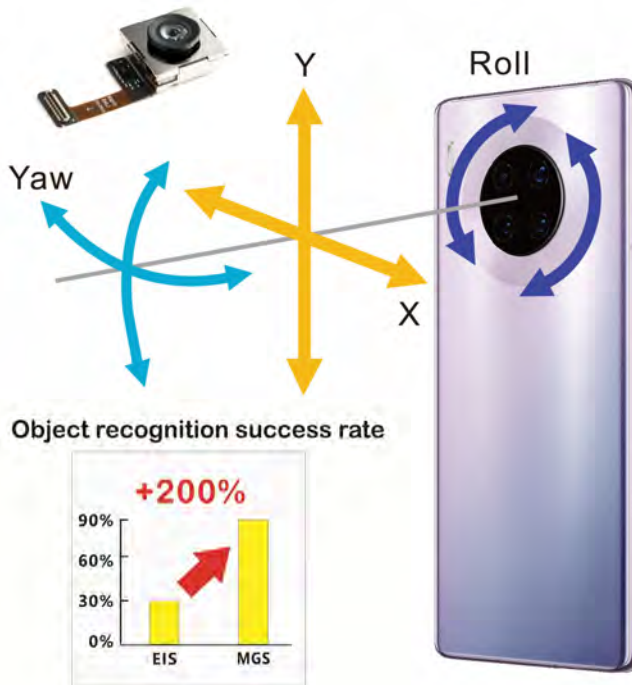
Robots



**Wearable
Cameras**

Micro Gimbal Stabilizer (MGS) für Mobiltelefone

Der Micro Gimbal Stabilizer (MGS) passt in die kompakte Größe und ermöglicht es Smartphones und Tablet-PCs, klare Bilder in der sich bewegenden Umgebung aufzunehmen.



OIS

MGS

Die MGS-Kamera reduziert die Unschärfe in Umgebungen mit wenig Licht erheblich und unterstützt die dynamische Gesichts- und Objekterkennung mit 2-mal schnellerer Rate.

Diagonal 6.294 mm (Type 1/2.86) 12Mega-Pixel CMOS Image Sensor with Square Pixel for Color Cameras

IMX386-0APH5-C

General description and application

IMX386 is a diagonal 6.294 mm (Type 1/2.86) 12 Mega-pixel CMOS active pixel type stacked image sensor with a square pixel array. It adopts Exmor RS™ technology to achieve high speed image capturing by column parallel A/D converter circuits and high sensitivity and low noise image (comparing with conventional CMOS image sensor) through the backside illuminated imaging pixel structure. R, G, and B pigment primary color mosaic filter is employed. By introducing spatially varying exposure technology, high dynamic range still pictures and movies are achievable. It equips an electronic shutter with variable integration time. It operates with three power supply voltages: analog 2.7 V, digital 1.1 V and 1.8 V for input/output interface and achieves low power consumption.

In addition, this product is designed for use in cellular phone and tablet pc. When using this for another application, Sony does not guarantee the quality and reliability of product. Therefore, don't use this for applications other than cellular phone and tablet pc. Consult your Sony sales representative if you have any questions.

Functions and Features

- ◆ Back-illuminated and stacked CMOS image sensor Exmor RS
- ◆ Phase Detection Auto Focus (PDAF)
- ◆ High Density Phase Detection Pixels
- ◆ High Signal to Noise Ratio and High Dynamic Range by 1.25μm x 1.25μm unit cell size
- ◆ High Frame Rate 30fps@Full resolution / 60fps@4K2K / 120fps@1080p
- ◆ New synchronization operation for dual camera system
- ◆ Built-in 2D Dynamic Defect Pixel Correction
- ◆ 4-ch Lens Shading Correction (LSC)
- ◆ Built-in temperature sensor
- ◆ Output video format of RAW10
- ◆ Pixel binning readout and V sub-sampling function
- ◆ Two PLLs for independent clock generation for pixel control and data output interface
- ◆ CSI-2 serial data output (MIPI 2lane/4lane, Max. 1.6Gbps/lane, D-PHY spec. ver. 1.2 compliant)
- ◆ 2-wire serial communication
- ◆ 6.6K bit of OTP ROM for user

Exmor RS

Sony reserves the right to change products and specifications without prior notice.

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Application circuits shown, if any, are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits.

Device Structure

◆ CMOS image sensor	
◆ Image size	: Diagonal 6.294 mm (Type 1/2.86)
◆ Total number of pixels	: 4048 (H) × 3096 (V) approx. 12.53 M pixels
◆ Number of effective pixels	: 4048 (H) × 3032 (V) approx. 12.27 M pixels
◆ Number of active pixels	: 4032 (H) × 3016 (V) approx. 12.16 M pixels
◆ Chip size	: 6.240 mm (H) × 4.672 mm (V)
◆ Unit cell size	: 1.25 μm (H) × 1.25 μm (V)
◆ Substrate material	: Silicon

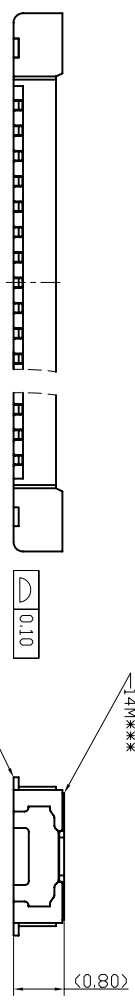
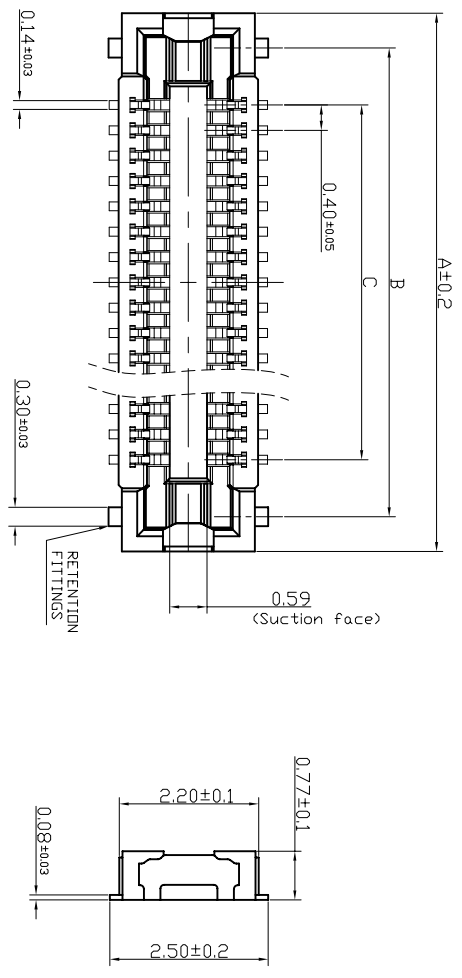
Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	notes
Supply voltage (analog)	VANA	-0.3 to +3.3	V	refer to VSS level
Supply voltage (digital)	VDIG	-0.3 to +1.8	V	
Supply voltage (interface)	VIF	-0.3 to +3.3	V	
Input voltage (digital)	VI	-0.3 to +3.3	V	
Output voltage (digital)	VO	-0.3 to +3.3	V	
Guaranteed Operating temperature	TOPR	-20 to +70	°C	
Guaranteed storage temperature	TSTG	-30 to +80	°C	
Guaranteed performance temperature	TSPEC	-20 to +60	°C	

Recommended Operating Voltage

Item	Symbol	Ratings	Unit	notes
Supply voltage (analog)	VANA	2.7 +0.2/-0.1	V	refer to VSS level
Supply voltage (digital)	VDIG	1.1 ± 0.1	V	
Supply voltage (interface)	VIF	1.8 ± 0.1	V	

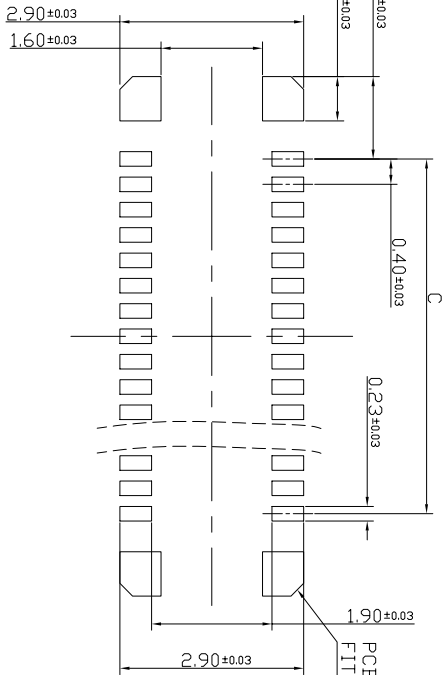
REV	ECN NO	DRA	APPD	DATE
A	FIRST RELEASE	George Gao	Human Zhou	2013.09.18
B	SECOND VERSIONS	George Gao	Human Zhou	2015.10.22



- Specifications:
- 1) Material:
1-1.Molded portion: LCP resin (UL94 V-0)
1-2.Contact and Post: Copper alloy.
- 2) Surface treatment:
2-1.Terminal portion: Base: Ni plating Surface: Au plating (except the terminal tips) ; Exposed nickel portions.
2-2.Metal clips: Base: Ni plating Surface: Au flash plating (except the terminal tips) Or: Base: Ni plating Surface: Sn flash plating (except the terminal tips)
- 3) Characteristics:
3-1. Rated voltage: 60V AC/DC
3-2. Rated current: 0.3A/contact (Max. 5A at total contact)
3-3. Insulation resistance: Min. 1000M Ω (initial)
3-4. Breakdown voltage: 150V AC for 1 min.
3-5.Saltwater spray resistance (header and socket mated): 24 hours, insulation resistance min.100M Ω , contact resistance max. 90m Ω
3-6. Contact resistance: Max. 90m Ω
3-7. Ambient temperature: -55℃~+85℃
3-8. Storage temperature: -55℃~+85℃ (product only); -40℃~+50℃ (emboss packing)
3-9. Composite insertion force: Max. 0.981N/contacts X contacts (initial)
3-10. Composite removal force: Min. 0.165N/contacts X contacts
3-11. Post holding force: Min. 0.49N/contacts
3-12. Insertion and removal life: 50 times

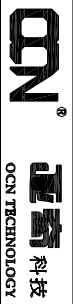
TABLE:

70	16.50	15.40	13.60
50	12.50	11.40	9.60
40	10.50	9.40	7.60
34	9.30	8.20	6.40
30	8.50	7.40	5.60
24	7.30	6.20	4.40
16	5.70	4.60	2.80
12	4.90	3.80	2.00
10	4.50	3.40	1.60
NUMBER DF CONTACTS	A	B	C



OK-14F***-04

PITCH-0.4MM
NUMBER DF CONTACTS



DIMENTION IN mm		OCN 芯奇科技 OCN TECHNOLOGY			
TOLERANCE UNLESS OTHERWISE SPECIFIED		APPR:	TITLE: 0.4MM BTB (MATING HEIGHT 0.8H)		
±0.20		±2°		OK-14F***-04	
.0 ±0.10		.0 ±1°			
.00 ±0.05		.00±0.5°			
.000±0.03		.000±0.3°			
		DRA: George Gao 2015.10.22	PROU	QTY	SIZE
				1/1	1:1
					REV B

RECOMMENDED PCB LAYOUT

REV	ECN NO	DRA	APPD	DATE
A	FIRST RELEASE	George Gao	Human Zhou	2013.09.12

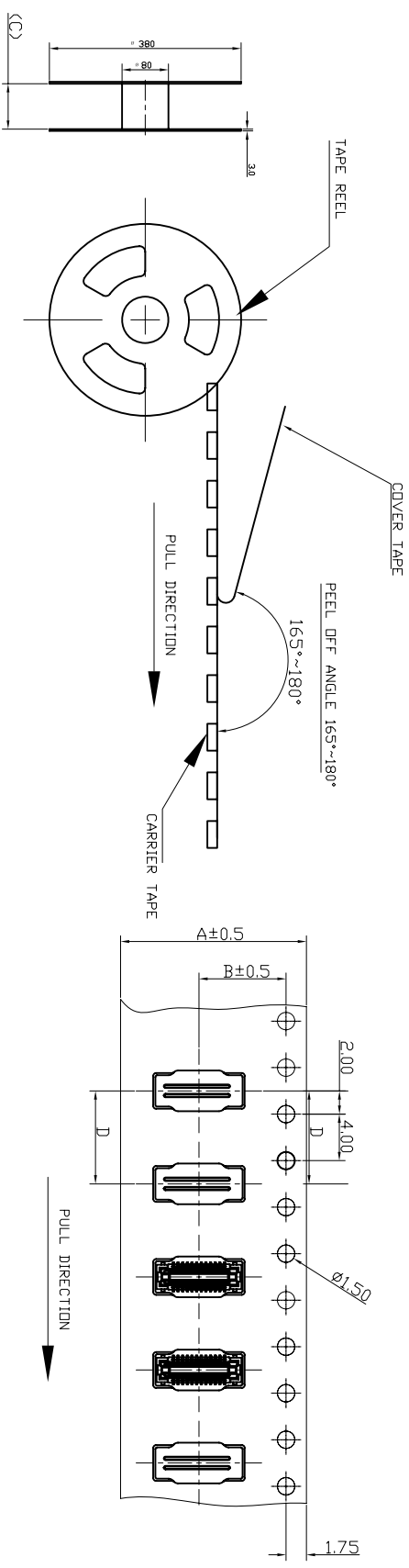


TABLE:

70	24.00	11.50	25.4	8.00	10000
50				8.00	10000
40				4.00	20000
34				4.00	20000
30	16.00	7.50	17.4	8.00	10000
24					
16					
12					
10	A	B	C	D	QTY/REEL
NUMBER OF CONTACTS					

DIMENTION IN mm		OCN[®] 壹奇科技 OCN TECHNOLOGY			
TOLERANCE UNLESS OTHERWISE SPECIFIED		TITLE: 0.4MM BTB (MATING HEIGHT 0.8H)			
. ± 0.20	. ± 2°	APPRO: George Gao 2013.09.18			
.0 ± 0.10	.0 ± 1°				
.00 ± 0.05	.00 ± 0.5°				
.000 ± 0.03	.000 ± 0.3°				
DWG NO: OK-14F***-04		DRA: George Gao 2013.09.18			
PROJ		REV			
SIZE		SCALE			
SHEET		REV			
1/1		A			

Cameras Applications



Automotive Driver Pilot



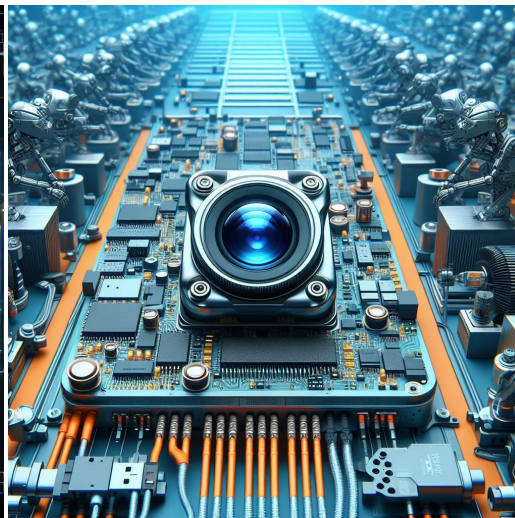
Live Streaming



Video Conference



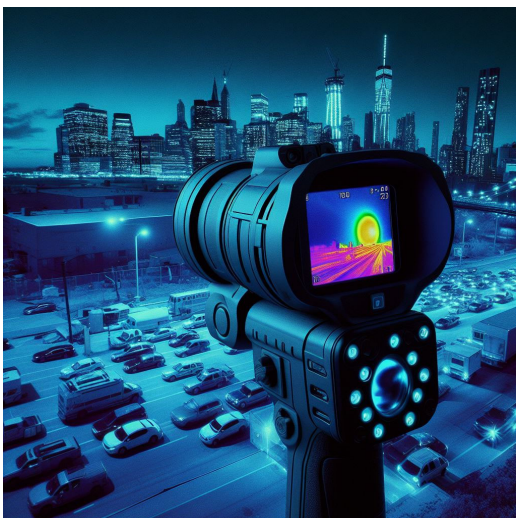
Eye Tracker Biometric Detection



Machine Vision



Agricultural Monitor



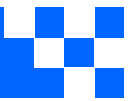
Night Vision Security



Drone and Sports Eagle Eyes



Interactive Pet Camera



Cameras Applications

your BEST camera module partner



IMAGING DEVICES



Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors	
Pin Signal	Description
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
MIPI Interface	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
DVP Parallel Interface	
D0 DO0 Y0	DVP data output port 0
D1 DO1 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 DO7 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 DO11 Y11	DVP data output port 11

Camera Reliability Test

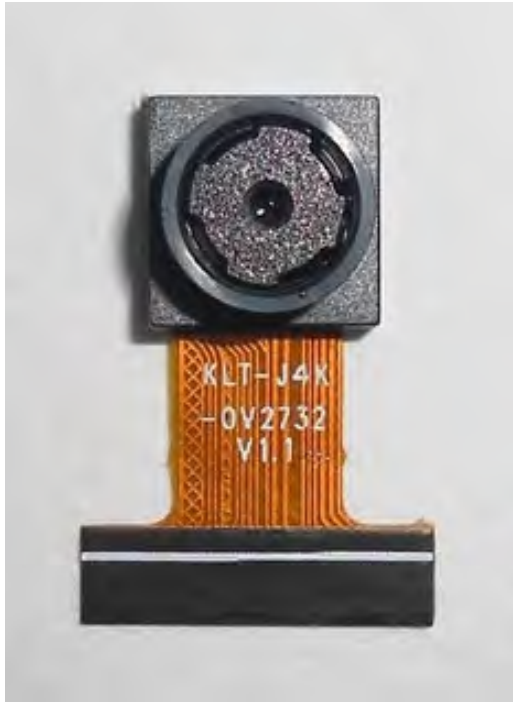
Reliability Inspection Item			Testing Method	Acceptance Criteria
Category		Item		
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional



Inspection Item		Inspection Method	Standard of Inspection		
Category					
Item					
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.	
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Gap	The Naked Eye	Meet the Height Standard	
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard	
		Contamination	The Naked Eye	No Effect On Resolution Standard	
		Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
	Function	Image	No Communication	Test Board	Not Allowed
			Bright Pixel	Black Board	Not Allowed In the Image Center
Dark Pixel			White board	Not Allowed In the Image Center	
Blurry			The Naked Eye	Not Allowed	
No Image			The Naked Eye	Not Allowed	
Vertical Line			The Naked Eye	Not Allowed	
Horizontal Line			The Naked Eye	Not Allowed	
Light Leakage			The Naked Eye	Not Allowed	
Blinking Image			The Naked Eye	Not Allowed	
Bruise			Inspection Jig	Not Allowed	
Resolution			Chart	Follows Outgoing Inspection Chart Standard	
Color			The Naked Eye	No Issue	
Noise			The Naked Eye	Not Allowed	
Corner Dark			The Naked Eye	Less Than 100px By 100px	
Color Resolution			The Naked Eye	No Issue	
Dimension			Height	The Naked Eye	Follows Approval Data Sheet
	Width	The Naked Eye	Follows Approval Data Sheet		
	Length	The Naked Eye	Follows Approval Data Sheet		
	Overall	The Naked Eye	Follows Approval Data Sheet		

KLT Package Solutions

KLT Camera Module



Complete with Lens Protection Film



Tray with Grid and Space

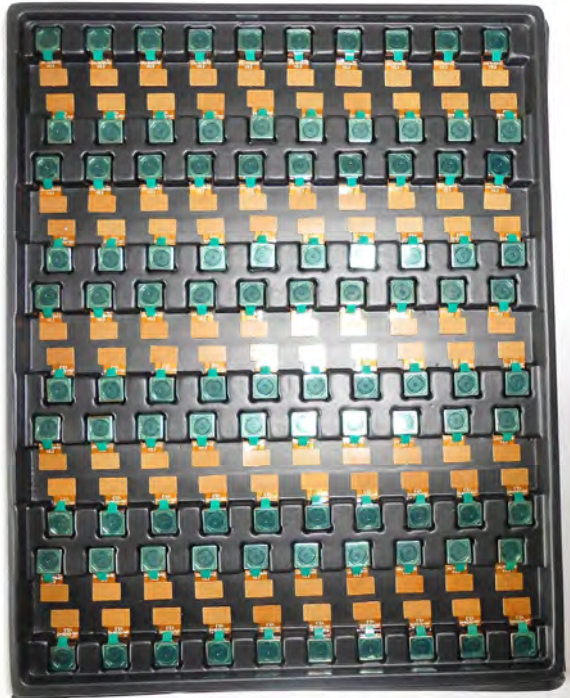


Place Cameras on the Tray



Camera Modules Package Solution

Full Tray of Cameras



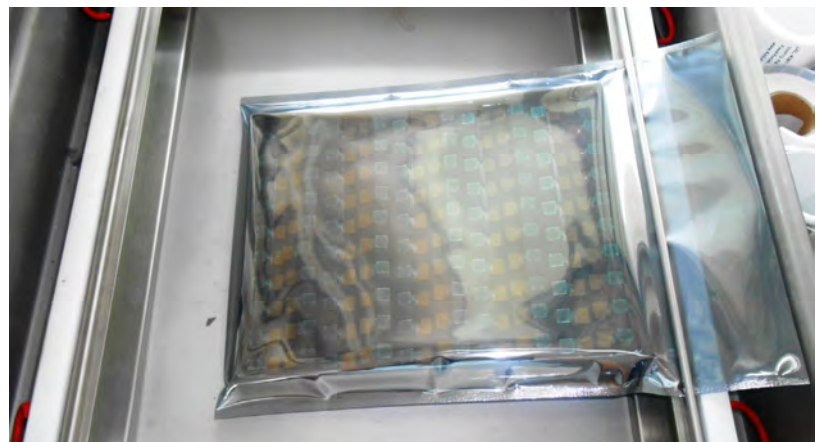
Cover Tray with Lid



Put Tray into Anti-Static Bag



Vacuum the Anti-Static Bag



Camera Modules Package Solution

Sealed Vacuum Bag with Labels

1. Model and Description 2. Quantity 3. Shipping Date 4. Caution



Large Order Package Solution

Place Foam Sheets Between Trays



Foam Sheets are Slightly Larger than Trays



Place Foam Sheets and Trays into Box



Foam Sheets are Tightly Fitting Box



Small Order Package Solution

Place Foam Sheets and Trays into Small Box



Foam Sheets are Nicely Fitting the Small Box



Package in Small Box for Shipment



Place Small Boxes into Larger Box



Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box



Carbon Box Ready for Shipment

1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution



Sample Order Package Solution

Place Sample into Small Anti-Static Bag



Place Connectors into Small Ant-Static Bag



Sample Labels on the Small Bag

1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution



Connectors Large Order Package Solution

Connectors in a Wheel



Label Connectors in the Wheel



The Wheel is Perfectly Fitting the Box

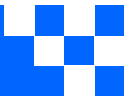


Connectors Box Ready for Shipment





CMOS CAMERA MODULES



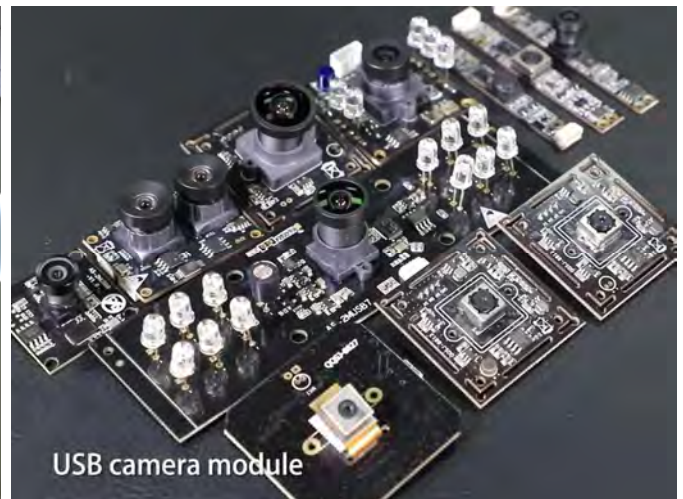
your BEST camera module partner

Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, www.KaiLapTech.com. Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequent events.



www.KaiLapTech.com sales@KaiLapTech.com Tel: (852) 6908 1256 Fax: (852) 3017 6778



CMOS CAMERA MODULES



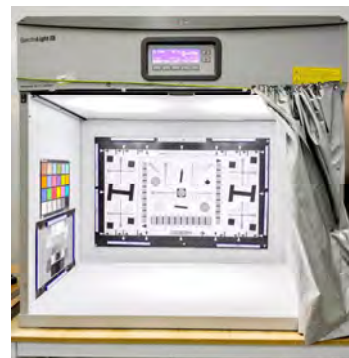
your BEST camera module partner

KLT Strength

Powerful Factory



Professional Service



Promised Delivery



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